	COUNT	DESCRIPTION O	F REVISIONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF R	VISIONS	BY	CHKD	DA	TE
Δ							Δ							
Δ							Δ							
APP	LICA	BLE STANDAR	D						-	1				
	Operating Temperature Ra			ge -55°C to +105°C (Note1) Te					corage -10°C to +60°				°C (Note3)	
RATING		Operating Humi Range	dity	20	% to 80	% (Note2	2)		Storage Humidity Range	40% to 70% (Note3) 250V AC/DC				
		Applicable Con	nector	DF51	K-*(D))S-2C (#	###)	,	Voltage					
		Applicable Cable	ə	ϕ 1.2 $\sim \phi$ 1.45 mm					Current	AWG 22 : 2A				
		Insulation Diamo	eter											
					S	SPECI	FIC	ATIO	NS					
		ITEM		TE	st me	THOD			REQUI	REMENT	S		QT	Α
CON	ISTR	UCTION	T						1					
General Examination		Visually and by measuring instrument.						According to drawing.				0	C	
Marking			Confirmed vis	sually.					According to drawing.				ο	c
ELE	CTRI	CAL CHARAC	TERISTIC	S										
Contact Resistance			20mV MAX, 1	mA (D	C or 10	00Hz).			30 mΩ MAX.					
Millivolt Level Method														
			I CTERISTIC	S										
Mecha	anical (Operation	30 times inse	rtion a	nd extra	action.			(1)Contact resistance:	30mΩ MA>	(
(Sn Plating))						②No damage, crack or looseness of parts.					-
Mecha	anical (Operation	50 times insertion and extraction.						①Contact resistance: 30mΩ MAX ②No damage, crack or looseness of parts.					
		(Au Plating												-
Vibrat	tion		Frequency 10) to 55	Hz, sing	gle ampliti	ude 0.	.75 mm,	①No electrical discontinuity of 1 μ s.					_
			at 10 cycles f	for 3 di	rection.				②No damage, crack or	looseness	of part	ts.	•	
Shock	ĸ		Acceleration	490 m⁄	⁄s² dura	tion of pu	ulse 1	1 ms at	3					
	Shook		times for 3 directions.											
		IMENTAL CH	Exposed at 4			aiditu 00	+- 05	0 0 C L	1 Contract methods	20 0 144	v			I
Damp Heat		1							() Contact resistance: 30 m Ω MAX.					
		(Steady State) (After leaving	the ro	om tem	perature	for 1	to 2h.)	②No damage, crack or	looseness	of par	ts.	0	-
Rapid (Change	of	Temperature	−55 °(C→ +10	05 °C			①Contact resistance:	30 mΩ MA	X.			
Temperatur)	Time	30min \rightarrow 30min Under 5 Cycles. (2)No damage, crack or looseness of parts.								ts.		
			(The transfer	ring tin	ne of th	e tank is	2 to 3	B MIN)					0	-
			(After leaving	-										

Note 1: Include the temperature rising by current.

Note 2: No condensing

Note 3: Apply to the condition of long term storage for unused products before pcb on board, after pcb board , operating temperature and humidity range is applied for interim storage during transportation.

			DRAV	VN	DESIGN	ED	CHECKED	APPROVED	RELEASED		
			J.S CI	IOI	J.S CH	OI	S.M.LIM	T.S KANG	ENG 20, 02, 13		
			17.12	.22	17.12.2	22	17.12.22	17.12.22	DEPT		
Unless otherwise specified, refer to IEC 60512.									\searrow		
NOTE QT: QUALIFICATION TEST	AT: AS	SURANCE TEST	O: APPL	ICABLI	E TEST						
HIROSE KOREA CO.,LTD. SPECIF			CATION SHEET			DF51K-22SCFA (800)					
CODE NO.(OLD) DRAWIN		NG NO.		CODE	CODE NO.						
CL ELC4-61			3			CL 6652-0043-1-800					